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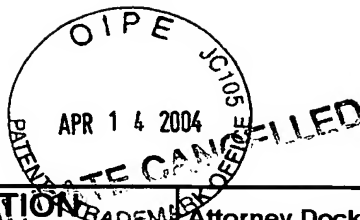
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**REISSUE APPLICATION  
DECLARATION  
(37 CFR 1.175)**

☒ Declaration Submitted with Initial Filing      OR      ☐ Declaration Submitted after Initial Filing (surcharge (37 CFR 1.16(e)) required)

Attorney Docket Number	AMK-AB0975(RI)
First Named Inventor	WonSun Shin
COMPLETE IF KNOWN	
Application Number	Filed Herewith
Filing Date	Filed Herewith
Art Unit	unknown
Examiner Name	unknown

I hereby declare that

Each inventor's residence, mailing address, and citizenship are as stated below next to their name.

I believe the inventor(s) named below to be the original and first inventor(s) of the subject matter which is described and claimed in U.S. Patent No. 6,395,578, granted May 28, 2002, and for which a reissue patent is sought on the invention entitled "**SEMICONDUCTOR PACKAGE AND METHOD FOR FABRICATING THE SAME**", the specification of which is attached hereto, and which is amended by way of the Preliminary Amendment For Reissue Application that also is attached hereto.

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				YES	NO
1999-18244	Rep. Of Korea	05/20/1999	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
1999-37925	Rep. Of Korea	09/07/1999	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
1999-37928	Rep. Of Korea	09/07/1999	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
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OR ☐ Registered practitioner(s) name/registration number listed below

Name	Registration Number	Name	Registration Number

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Name					
Address					
City		State		ZIP	
Country		Telephone	+1 (408) 451-5906		Fax +1 (408) 451-5908

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Name of Sole or First Inventor:

☐ A petition has been filed for this unsigned inventor

Given Name (first and middle (if any))	Family Name or Surname
Won Sun	Shin

Inventor's Signature					Date	Mar. 30, 2004	
Residence: City	Kyunggi-do	State	N/A	Country	Rep. Of Korea	Citizenship	Rep. Of Korea
Mailing Address	422-702 Kunyoung Apt., Youngtong-dong, 1047-1, Suwon-city						
City	Kyunggi-do	State	N/A	ZIP	N/A	Country	Rep. Of Korea

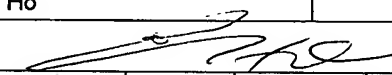

Name of Additional Joint Inventor, if any:

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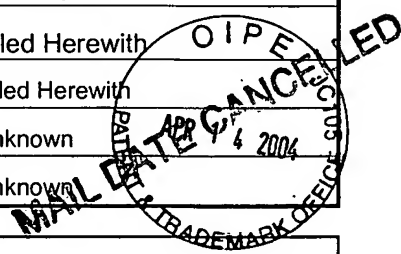
Given Name (first and middle (if any))	Family Name or Surname
Do Sung	Chun

Inventor's Signature					Date		
Residence: City	Tempe	State	AZ	Country	US	Citizenship	US
Mailing Address	7687 S. College Ave.						
City	Tempe	State	AZ	ZIP	85284	Country	US

☒ Additional inventors are being named on the 1 supplemental Additional Inventor(s) sheet(s) PTO/SB/02A attached hereto:

REISSUE APPLICATION DECLARATION					ADDITIONAL INVENTOR(S) Supplemental Sheet Page <u>1</u> of <u>1</u>		
<b>Name of Additional Joint Inventor, if any:</b>				<input type="checkbox"/> A petition has been filed for this unsigned inventor			
Given Name (first and middle (if any))				Family Name or Surname			
Sang Ho				Lee			
Inventor's Signature					Date		Mar. 7 <sup>th</sup> '04
Residence: City	Kyunggi-do	State	N/A	Country	Rep. Of Korea	Citizenship	Rep. Of Korea
Mailing Address		149-302 Jinheung Apt., Hwaseo-dong, Paldal-gu Suwon-city					
City	Kyunggi-do	State	N/A	ZIP	N/A	Country	Rep. Of Korea
<b>Name of Additional Joint Inventor, if any:</b>				<input type="checkbox"/> A petition has been filed for this unsigned inventor			
Given Name (first and middle (if any))				Family Name or Surname			
Seon Goo				Lee			
Inventor's Signature					Date		Mar. 20 '04
City	Kyunggi-do	State	N/A	Country	Rep. Of Korea	Citizenship	Rep. Of Korea
Mailing Address		6-305 Samsung Apt., 1028, Sanbon-dong, Kunpo-city					
City	Kyunggi-do	State	N/A	ZIP	N/A	Country	Rep. Of Korea
<b>Name of Additional Joint Inventor, if any:</b>				<input type="checkbox"/> A petition has been filed for this unsigned inventor			
Given Name (first and middle (if any))				Family Name or Surname			
Vincent				DiCaprio			
Inventor's Signature					Date		
City	Chandler	State	AZ	Country	US	Citizenship	Canada
Mailing Address		658 E. Scorpio Place					
City	Chandler	State	AZ	ZIP	85249	Country	US
<b>Name of Additional Joint Inventor, if any:</b>				<input type="checkbox"/> A petition has been filed for this unsigned inventor			
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Mailing Address							
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		First Named Inventor	WonSun Shin
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Place Customer  
Number Bar  
Code Label here

OR ☐ Registered practitioner(s) name/registration number listed below

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Address					
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Country		Telephone	+1 (408) 451-5906	Fax	+1 (408) 451-5908

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

**Name of Sole or First Inventor:**

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Given Name (first and middle (if any))	Family Name or Surname
Won Sun	Shin

Inventor's Signature	Date																								
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td>Residence: City</td> <td>Kyunggi-do</td> <td>State</td> <td>N/A</td> <td>Country</td> <td>Rep. Of Korea</td> <td>Citizenship</td> <td>Rep. Of Korea</td> </tr> <tr> <td>Mailing Address</td> <td colspan="7">422-702 Kunyoung Apt., Youngtong-dong, 1047-1, Suwon-city</td> </tr> <tr> <td>City</td> <td>Kyunggi-do</td> <td>State</td> <td>N/A</td> <td>ZIP</td> <td>N/A</td> <td>Country</td> <td>Rep. Of Korea</td> </tr> </table>	Residence: City	Kyunggi-do	State	N/A	Country	Rep. Of Korea	Citizenship	Rep. Of Korea	Mailing Address	422-702 Kunyoung Apt., Youngtong-dong, 1047-1, Suwon-city							City	Kyunggi-do	State	N/A	ZIP	N/A	Country	Rep. Of Korea	
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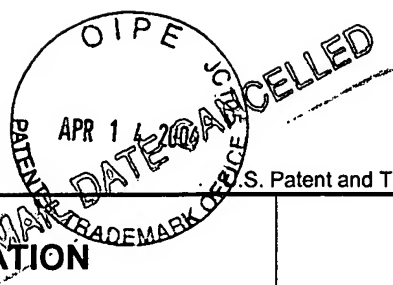
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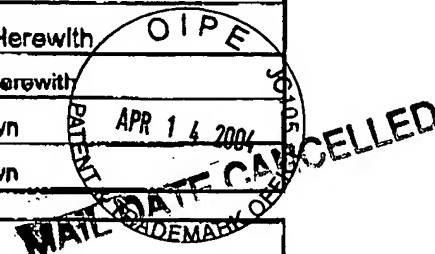
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SangHo			Lee					
Inventor's Signature					Date			
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SeonGoo			Lee					
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Vincent			DiCaprio					
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Name

Address

City

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ZIP

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+1 (408) 451-5906

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Won Sun

Family Name or Surname

Shin

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Date

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Country

Rep.  
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Mailing Address

422-702 Kunyoung Apt., Youngtong-dong, 1047-1, Suwon-city

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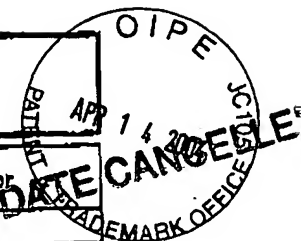
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Name of Additional Joint Inventor, if any:				<input type="checkbox"/> A petition has been filed for this unsigned inventor			
Given Name (first and middle (if any))				Family Name or Surname			
Sang Ho				Lee			
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Name of Additional Joint Inventor, if any:				<input type="checkbox"/> A petition has been filed for this unsigned inventor			
Given Name (first and middle (if any))				Family Name or Surname			
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Name of Additional Joint Inventor, if any:				<input type="checkbox"/> A petition has been filed for this unsigned inventor			
Given Name (first and middle (if any))				Family Name or Surname			
Vincent				DiCaprio			
Inventor's Signature				Date		03/31/2004	
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Name of Additional Joint Inventor, if any:				<input type="checkbox"/> A petition has been filed for this unsigned inventor			
Given Name (first and middle (if any))				Family Name or Surname			
Inventor's Signature				Date			
City		State		Country	US	Citizenship	
Mailing Address							
City		State		ZIP		Country	US



PTO/SB/82 (09-03)

Approved for use through 11/30/2005. OMB 0951-0035  
U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE

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**REVOCATION OF POWER OF  
ATTORNEY WITH  
NEW POWER OF ATTORNEY  
AND  
CHANGE OF CORRESPONDENCE ADDRESS**

Application Number	Not Yet Assigned
Filing Date	Herewith
First Named Inventor	Won Sun Shin
Art Unit	Not Yet Assigned
Examiner Name	Not Yet Assigned
Attorney Docket Number	AMK-AB0975(RI)

I hereby revoke all previous powers of attorney given in the above-identified application.

☐ A Power of Attorney is submitted herewith.

OR

☒ I hereby appoint the practitioners associated with the Customer Number:

022888

☒ Please change the correspondence address for the above-identified application to:

☒ The address associated with  
Customer Number:

022888

OR

☐ Firm or  
Individual Name

Address

Address

City

State

Zip

Country

Telephone

Fax

I am the:

☐ Applicant/Inventor.

☒ Assignee of record of the entire interest. See 37 CFR 3.71.  
Statement under 37 CFR 3.73(b) is enclosed. (Form PTO/SB/96)

**SIGNATURE of Applicant or Assignee of Record**

Name Paul W. Davis, Vice President - Intellectual Property, Amkor Technology, Inc.

Signature

Date

Telephone

480 821-5000

NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below.

☐ \*Total of \_\_\_\_\_ forms are submitted.

This collection of information is required by 37 CFR 1.35. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 3 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

If you need assistance in completing the form, call 1-800-PTO-9199 and select option 2.



PTO/SB/53 (03-03)

Approved for use through 01/31/2004. OMB 0651-0033  
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**REISSUE APPLICATION: CONSENT OF ASSIGNEE;  
STATEMENT OF NON-ASSIGNMENT**

Docket Number (Optional)

AMK-AB0975(RI)

This is part of the application for a reissue patent based on the original patent identified below.

Name of Patentee(s)

Won Sun Shin, Do Sung Chun, Sang Ho Lee, Seon Goo Lee, Vincent DiCaprio

Patent Number

8,395,578

Date Patent Issued

May 28, 2002

Title of Invention

SEMICONDUCTOR PACKAGE AND METHOD FOR FABRICATING THE SAME

1. ☒ Filed herein is a statement under 37 CFR 3.73(b). (Form PTO/SB/96)
2. ☐ Ownership of the patent is in the inventor(s), and no assignment of the patent is in effect.

One of boxes 1 or 2 above must be checked. If multiple assignees, complete this form for each assignee. If box 2 is checked, skip the next entry and go directly to "Name of Assignee".

The written consent of all assignees and inventors owning an undivided interest in the original patent is included in this application for reissue.

The assignee(s) owning an undivided interest in said original patent is/are Amkor Technology, Inc.  
and the assignee(s) consents to the accompanying application for reissue.

The undersigned, whose title is supplied below, is authorized to act on behalf of Amkor Technology, Inc.

Name of assignee/inventor (if not assigned)

Amkor Technology, Inc.

Signature

Date

4/2/04

Typed or printed name and title of person signing for assignee (if assigned)

Paul W. Davis  
Vice President - Intellectual Property  
Amkor Technology, Inc.

This collection of information is required by 37 CFR 1.172. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 6 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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PTO/SB/86 (08-03)

Approved for use through 07/31/2006. OMB 0651-0031  
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**STATEMENT UNDER 37 CFR 3.73(b)**Applicant/Patent Owner: Amkor Technology, Inc.Application No./Patent No.: 6,395,578 Filed/Issue Date: May 28, 2002Entitled: SEMICONDUCTOR PACKAGE AND METHOD FOR ABRICATING THE SAME

Amkor Technology, Inc. a corporation  
 (Name of Assignee) (Type of Assignee, e.g., corporation, partnership, university, government agency, etc.)

states that it is:

1. ☒ the assignee of the entire right, title, and interest; or
2. ☐ an assignee of less than the entire right, title and interest.  
 The extent (by percentage) of its ownership interest is \_\_\_\_\_ %  
 in the patent application/patent identified above by virtue of either:

A. ☐ An assignment from the inventor(s) of the patent application/patent identified above. The assignment was recorded in the United States Patent and Trademark Office at Reel \_\_\_\_\_, Frame \_\_\_\_\_, or for which a copy thereof is attached.

OR

B. ☒ A chain of title from the inventor(s), of the patent application/patent identified above, to the current assignee as shown below:

1. From: Vincent DiCaprio To: Amkor Technology, Inc.  
 The document was recorded in the United States Patent and Trademark Office at Reel 010833, Frame 0369, or for which a copy thereof is attached.  
Won Sun Shin, Do Sung Chun,  
Sang Ho Lee, and Seon Goo Lee To: Amkor Technology, Inc. and  
Amkor Technology Korea, Inc.  
 The document was recorded in the United States Patent and Trademark Office at Reel 011187, Frame 0236, or for which a copy thereof is attached.
3. From: Amkor Technology Korea, Inc. To: Amkor Technology, Inc.  
 The document was recorded in the United States Patent and Trademark Office at Reel 013323, Frame 0853, or for which a copy thereof is attached.

☐ Additional documents in the chain of title are listed on a supplemental sheet.

☐ Copies of assignments or other documents in the chain of title are attached.  
 (NOTE: A separate copy (i.e., the original assignment document or a true copy of the original document) must be submitted to Assignment Division in accordance with 37 CFR Part 3, if the assignment is to be recorded in the records of the USPTO. See MPEP 302.08)

The undersigned (whose title is supplied below) is authorized to act on behalf of the assignee.

4/2/04  
 Date  
480 821-5000  
 Telephone number

Paul W. Davis  
 Typed or printed name  
Paul W. Davis  
 Signature  
Vice President - Intellectual Property  
 Title

This collection of information is required by 37 CFR 3.73(b). The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 12 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

If you need assistance in completing the form, call 1-800-PTO-9199 and select option 2.